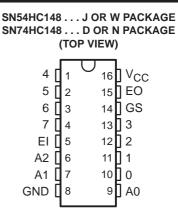
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- Encode Eight Data Lines to 3-Line Binary (Octal)
- Applications Include:
  n-Bit Encoding
  Code Converters and Con
  - Code Converters and Generators
- Package Options Include Plastic Small-Outline (D) and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

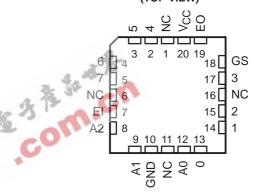
#### description

The 'HC148 feature priority decoding of the inputs to ensure that only the highest-order data line is encoded. These devices encode eight data lines to 3-line (4-2-1) binary (octal). Cascading circuitry (enable input EI and enable output EO) has been provided to allow octal expansion without the need for external circuitry. Data inputs and outputs are active at the low logic level.

The SN54HC148 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C. The SN74HC148 is characterized for operation from  $-40^{\circ}$ C to 85°C.



SN54HC148 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

INPUTS									C	OUTPUT	S		
EI	0	1	2	3	4	5	6	7	A2	A1	A0	GS	EO
н	Х	Х	Х	Х	Х	Х	Х	Х	н	Н	Н	Н	Н
L	н	Н	Н	Н	Н	Н	Н	Н	н	Н	Н	н	L
L	Х	Х	Х	Х	Х	Х	Х	L	L	L	L	L	н
L	Х	Х	Х	Х	Х	Х	L	Н	L	L	Н	L	н
L	Х	Х	Х	Х	Х	L	Н	Н	L	Н	L	L	н
L	Х	Х	Х	Х	L	Н	Н	Н	L	Н	Н	L	н
L	Х	Х	Х	L	Н	Н	Н	Н	н	L	L	L	н
L	Х	Х	L	Н	Н	Н	Н	Н	н	L	Н	L	н
L	Х	L	Н	Н	Н	Н	Н	Н	н	Н	L	L	н
L	L	Н	Н	Н	Н	Н	Н	Н	н	Н	Н	L	н

FUNCTION TABLE



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

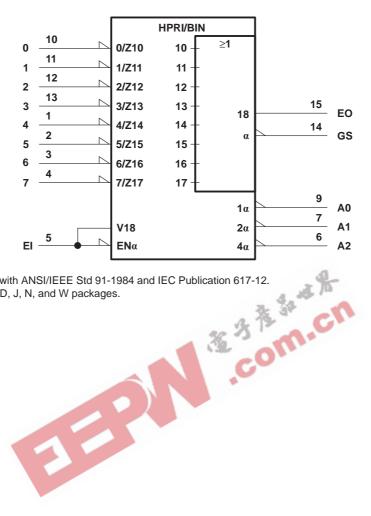
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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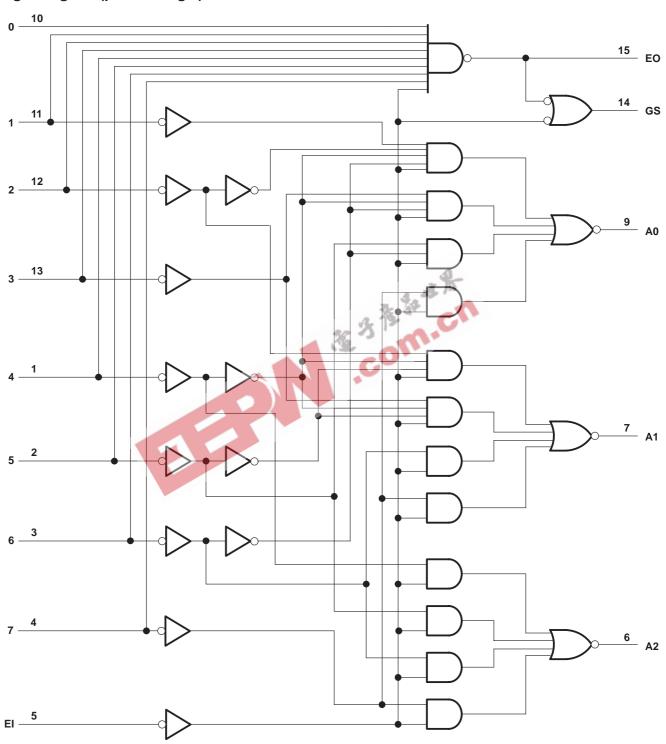
#### logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, N, and W packages.



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logic diagram (positive logic)

Pin numbers shown are for the D, J, N, and W packages.



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#### absolute maximum ratings over operating free-air temperature range<sup>†</sup>

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see Note 1)	
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) (see Note 1)	±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V <sub>CC</sub> or GND	±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): D package	113°C/W
N package	78°C/W
Storage temperature range, T <sub>stg</sub>	. −65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

				54HC148	SN74HC148			UNIT
			MIN	NOM MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		2	5 6	2	5	6	V
		$V_{CC} = 2 V$	1.5		1.5			
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15		3.15			V
		$V_{CC} = 6 V$	4.2		4.2			
	Low-level input voltage	V <sub>CC</sub> = 2 V	0	0.5	0		0.5	
VIL		V <sub>CC</sub> = 4.5 V	0	1.35	0		1.35	V
		$V_{CC} = 6 V$	0	1.8	0		1.8	
VI	Input voltage		0	VCC	0		VCC	V
Vo	Output voltage		0	VCC	0		VCC	V
		$V_{CC} = 2 V$	0	1000	0		1000	
tt	Input transition (rise and fall) time	V <sub>CC</sub> = 4.5 V	0	500	0		500	ns
		V <sub>CC</sub> = 6 V	0	400	0		400	
TA	Operating free-air temperature		-55	125	-40		85	°C

#### recommended operating conditions

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	TEST OF	v <sub>cc</sub>	T <sub>A</sub> = 25°C			SN54HC148		SN74HC148			
PARAMETER	TEST CO		MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
			2 V	1.9	1.998		1.9		1.9		V
		I <sub>OH</sub> = -20 μA	4.5 V	4.4	4.499		4.4		4.4		
V <sub>OH</sub>	$V_{I} = V_{IH} \text{ or } V_{IL}$		6 V	5.9	5.999		5.9		5.9		
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		
		I <sub>OH</sub> = -5.2 mA	6 V	5.48	5.8		5.2		5.34		
	VI = VIH or VIL		2 V		0.002	0.1		0.1		0.1	V
		I <sub>OL</sub> = 20 μA	4.5 V		0.001	0.1		0.1		0.1	
VOL			6 V		0.001	0.1		0.1		0.1	
		I <sub>OL</sub> = 4 mA	4.5 V		0.17	0.26		0.4		0.33	
		I <sub>OL</sub> = 5.2 mA	6 V		0.15	0.26		0.4		0.33	
l	$V_{I} = V_{CC} \text{ or } 0$		6 V		±0.1	±100		±1000		±1000	nA
ICC	$V_I = V_{CC} \text{ or } 0,$	IO = 0	6 V			8		160		80	μA
Ci			2 V to 6 V		3	10		10		10	pF

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

switching characteristics over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

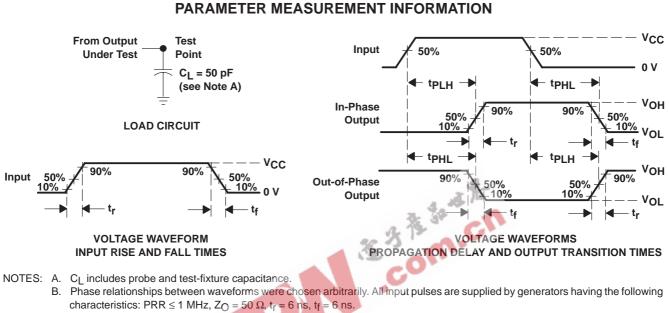
	FROM	то		$T_A = 2$	25°C		SN54H	IC148	SN74H	C148	
PARAMETER	(INPUT)	(OUTPUT)	Vcc		(P	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		69	180		270		225	
	1–7	A0, A1, or A2	4.5 V	:	23	36		54		45	
			6 V		21	31		46		38	
			2 V		60	150		225		190	
		EO	4.5 V	:	20	30		45		38	
	0–7		6 V		17	26		38		33	
	0 1		2 V		75	190		285		240	
		GS	4.5 V	:	25	38		57		48	
terd			6 V	:	21	32		48		41	ns
<sup>t</sup> pd		A0, A1, or A2	2 V		78	195		295		245	113
			4.5 V	:	26	39		59		49	
			6 V	:	22	33		50		42	
			2 V		57	145		220		180	
	EI	GS	4.5 V		19	29		44		36	
			6 V		16	25		38		31	
			2 V		66	165		250		205	
		EO	4.5 V		22	33		50		41	
			6 V		19	28		43		35	
			2 V		28	75		110		95	
tt		Any	4.5 V		8	15		22		19	ns
			6 V		6	13		19		16	



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## operating characteristics, T<sub>A</sub> = 25°C

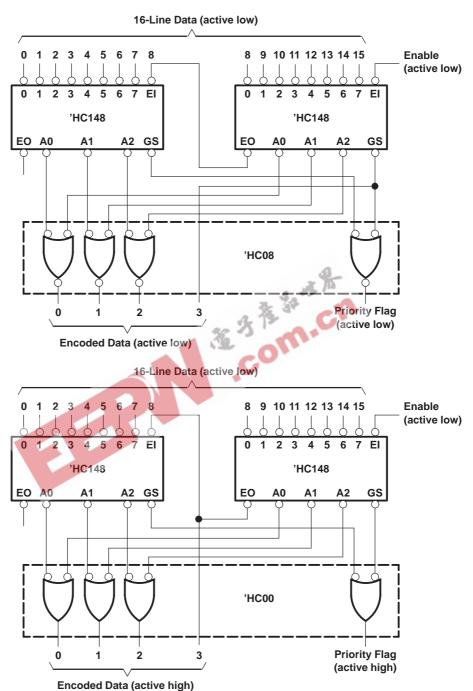
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load	35	pF



- C. The outputs are measured one at a time with one input transition per measurement.
- D. tpLH and tpHL are the same as tpd.

#### Figure 1. Load Circuit and Voltage Waveforms

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#### APPLICATION INFORMATION

Figure 2. Priority Encoder for 16 Bits

Since the 'HC148 is a combinational logic circuit, wrong addresses can appear during input transients. Moreover, a change from high to low at EI can cause a transient low on GS when all inputs are high. This must be considered when strobing the outputs.

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